

ABSTRACT

5 There is provided a resist composition used for the
production of printed boards, which comprises (A) a resin
component, (B) a photopolymerization initiator, (C) water
and (D) an organic solvent, wherein the organic solvent
(D) contains:

10 (D-1) at least one organic solvent selected from the
group consisting of an α -hydroxycarboxylate ester, a β -
alkoxycarboxylate ester, a 1,3-diol compound and a 1,3-
diol compound derivative, and

 (D-2) an organic solvent having a hydroxyl group
other than (D-1).